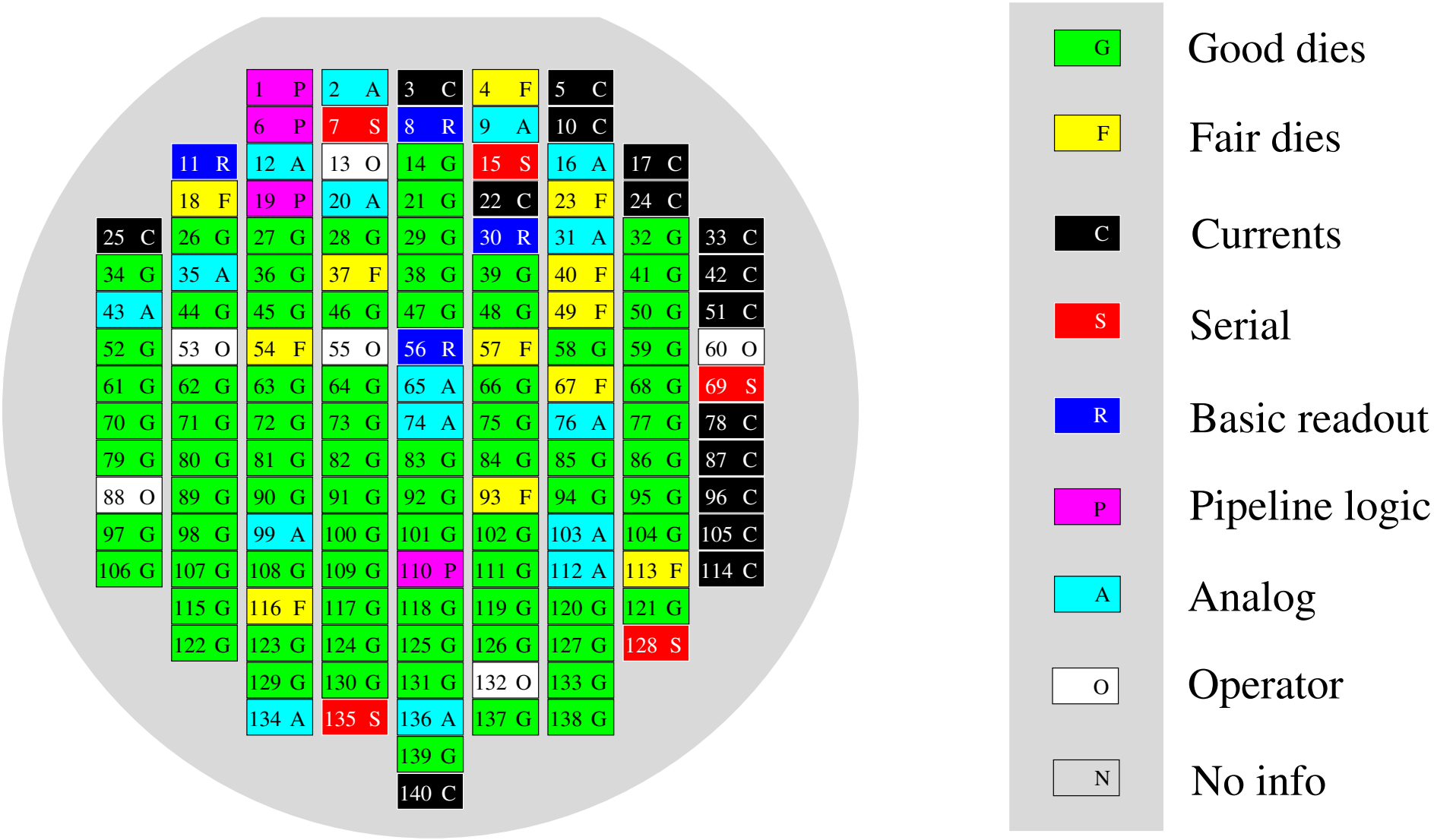
Types of die failures for wafer 87 s/n: Y21316-08-01 (not backplated)

Date: 04/21/99